

Celapex® CL 500G

Celanese Corporation - Polyetheretherketone

Tuesday, November 5, 2019

General Information

Product Description

Celapex® 500G is an standard flow unreinforced polyether ether ketone (PEEK) for injection molding and extrusion. It has superior chemically resistant to aggressive environments. The typical applications of this product are extrusion stock shapes, and injection molded parts with higher impact, ductility, creep, and fatigue.

General			
Material Status	Commercial: Active		
Availability	 Africa & Middle East Asia Pacific	EuropeLatin America	North America
Features	Chemical ResistantCreep Resistant	DuctileFatigue Resistant	Good Impact Resistance
Processing Method	Extrusion	Injection Molding	

ASTM & IS	O Properties 1		
Physical	Nominal Value	Unit	Test Method
Density	1.30	g/cm³	ISO 1183
Melt Mass-Flow Rate (MFR) (380°C/5.0 kg)	10	g/10 min	ISO 1133
Molding Shrinkage			ISO 294-4
Across Flow	1.3	%	
Flow	1.0	%	
Mechanical	Nominal Value	Unit	Test Method
Tensile Stress (Yield)	14500	psi	ISO 527-2/1A/50
Tensile Strain (Break)	45	%	ISO 527-2/1A/50
Flexural Modulus (73°F)	595000	psi	ISO 178
Flexural Stress (73°F)	23900	psi	ISO 178
Impact	Nominal Value	Unit	Test Method
Charpy Notched Impact Strength (73°F)	3.3	ft·lb/in²	ISO 179/1eA
Charpy Unnotched Impact Strength (73°F)	No Break		ISO 179/1eU
Notched Izod Impact Strength (73°F)	3.6	ft·lb/in²	ISO 180/A
Unnotched Izod Impact Strength (73°F)	No Break		ISO 180
Thermal	Nominal Value	Unit	Test Method
Heat Deflection Temperature (264 psi, Unannealed)	306	°F	ISO 75-2/A
Glass Transition Temperature ²	289	°F	ISO 11357-2
Melting Temperature ²	649	°F	ISO 11357-3
CLTE - Flow			ISO 11359-2
_3	2.5E-5	in/in/°F	
4	6.7E-5	in/in/°F	
Electrical	Nominal Value		Test Method
Volume Resistivity		ohms·cm	IEC 60093
Electric Strength		V/mil	IEC 60243-1
Relative Permittivity			IEC 60250
50 Hz	3.00		
1 MHz	3.10		
Dissipation Factor (1 MHz)	4.0E-3		IEC 60250



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Electrical	Nominal Value Unit	Test Method
Comparative Tracking Index ⁵	150 V	IEC 60112

Processing Information			
njection	Nominal Value Unit		
Drying Temperature	284 to 302 °F		
Drying Time	4.0 to 8.0 hr		
Suggested Max Moisture	0.030 %		
Processing (Melt) Temp	734 to 770 °F		
Mold Temperature	338 to 383 °F		
Injection Rate	Moderate-Fast		
Back Pressure	< 290 psi		

Notes

¹ Typical properties: these are not to be construed as specifications.

² 10°C/min

³ below

⁴ above

⁵ 100 Drop Voltage